

L Number	Hits	Search Text	DB	Time stamp
1	159252	(USUI or HIDEKI or IGARASHI or SAKAMOTO).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:43
2	215	((USUI or HIDEKI or IGARASHI or SAKAMOTO).in.) and plasma same irradiat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:43
3	74	((((USUI or HIDEKI or IGARASHI or SAKAMOTO).in.) and plasma same irradiat\$3) and (resin or polymer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:44
4	5	((((USUI or HIDEKI or IGARASHI or SAKAMOTO).in.) and plasma same irradiat\$3) and (resin or polymer)) and (resin or polymer) same (over or cover\$3) same (die or chip or IC or element or circuit)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:45
5	11	438/106.cccls. and irradiat\$3 same plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:55
-	522	438/597.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:42
-	37	438/597.cccls. and resin and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:16
-	42	438/124.cccls. and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:16
-	0	(438/597.cccls. and resin and plasma) and (438/124.cccls. and plasma) and ((irradiating or plasma) same resin)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:17
-	43	(438/597.cccls. and resin and plasma) or (438/124.cccls. and plasma) and ((irradiating or plasma) same resin)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:17
-	6	((438/597.cccls. and resin and plasma) or (438/124.cccls. and plasma) and ((irradiating or plasma) same resin)) and rough\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:36
-	4	6,596,559	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 16:02
-	2548	438/106.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 16:05
-	41	438/106.cccls. and rough\$6 and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:55
-	0	6713858.URPN.	USPAT	2004/06/22 17:21

-	27	("3013926" "4211824" "4251409" "4388132" "4680228" "5002808" "5098618" "5104944" "5121190" "5147084" "5391650" "5583747" "5683757" "5745984" "5948484" "6074895" "6248614" "6259155" "6284050" "6288900" "6294741" "6353420" "6512295" "6548909" "6596559" "6624507" "6642613").PN.	USPAT	2004/06/22 17:23
-	481	438/\$5.ccls. and resin and (openings same pads)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:26
-	407	(438/\$5.ccls. and resin and (openings same pads)) and (chip or die) and (top or over or covering)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:26
-	104	((438/\$5.ccls. and resin and (openings same pads)) and (chip or die) and (top or over or covering)) and exposing same pads	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:27
-	32	(((438/\$5.ccls. and resin and (openings same pads)) and (chip or die) and (top or over or covering)) and exposing same pads) and encapsulating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:27
-	3	(((438/\$5.ccls. and resin and (openings same pads)) and (chip or die) and (top or over or covering)) and exposing same pads) and encapsulating) and (O2 or oxygen)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:28
-	2	6689641.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 12:26
-	13	(US-6074895-\$ or US-5002808-\$ or US-6713858-\$ or US-6248655-\$ or US-6600224-\$ or US-6596559-\$ or US-6602803-\$ or US-5766979-\$ or US-6512295-\$ or US-4388132-\$ or US-6479409-\$ or US-6689641-\$).did. or (US-20020130397-\$).did.	USPAT; US-PGPUB	2004/06/23 12:51
-	1	((US-6074895-\$ or US-5002808-\$ or US-6713858-\$ or US-6248655-\$ or US-6600224-\$ or US-6596559-\$ or US-6602803-\$ or US-5766979-\$ or US-6512295-\$ or US-4388132-\$ or US-6479409-\$ or US-6689641-\$).did. or (US-20020130397-\$).did.) and (inert or helium or argon or neon).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 12:52
-	4	((US-6074895-\$ or US-5002808-\$ or US-6713858-\$ or US-6248655-\$ or US-6600224-\$ or US-6596559-\$ or US-6602803-\$ or US-5766979-\$ or US-6512295-\$ or US-4388132-\$ or US-6479409-\$ or US-6689641-\$).did. or (US-20020130397-\$).did.) and (inert or helium or argon or neon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 12:53
-	0	JP2001-230527	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:40
-	7704	(438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 11:52

-	5	((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 11:59
-	1210) and (plasma adj irradiating) ((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:00
-	61) and voltage (((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:00
-	30) and voltage) and (voltage same rf same plasma) (((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:01
-	28) and voltage) and (voltage same rf same plasma)) and (resin or polymer) ((((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:11
-	0) and voltage) and (voltage same rf same plasma)) and (resin or polymer)) and conductive ((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:11
-	1) and (backside adj conductive adj layer) (((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:14
-	11) or 438/597) and (backside adj conductive adj layer) 438/\$5 and (backside adj conductive adj layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:24
-	80	conductive same polymer same substrate same bias	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:25
-	23	(conductive same polymer same substrate same bias) and conductive and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:37
-	15	("4333793" "5001083" "5087857" "5362358" "5368685" "5439849" "5441595" "5468341" "5614060" "5683517" "5683538" "5877032" "5895740" "5942446" "6251791").PN.	USPAT	2004/07/02 12:34
-	0	(irradiat\$3 adj plasma) same (voltage same conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:38
-	0	(irradiat\$3 adj plasma) and (voltage same conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:39

-	0	(irradiat\$3 same plasma) and (voltage same conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/02 12:39
-	0	(irradiat\$3 same plasma) and (bias same conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/02 12:39
-	8	(irradiat\$3 same plasma) and bias and (conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/02 13:02
-	7	((irradiat\$3 same plasma) and bias and (conductive same backside)) and voltage	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/02 12:39
-	31	(irradiat\$3 same plasma) and ((metal or conductive) same backside) and (resin or polymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/02 12:49
-	53	(expos\$3 same plasma same (polymer or resin)) and ((metal or conductive) same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/02 12:49
-	4	((irradiat\$3 or expos\$3) same plasma) and ((connection same backside) same (cathode or anode))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/02 13:03